

TFT-LCD PRODUCT SPECIFICATION

PART NUMBER:	USMP-TT032WJ-01C-TP		
DESCRIPTION:	3.2" TFT LCD with 320 x 480 resolution, White LED B/L 16-bit interface for DBI Type B, and		
	Touch Panel.		

ISSUE DATE	APPROVED BY	CHECKED BY	PREPARED BY
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History of Version

Date	Ver.	Edi.	Description	Page	Design by
3/3/2009	01	001	NEW DRAWING	-	Raymond
4/29/2009	01	002	NEW SAMPLE	-	Raymond
					al: 23 Page

Total: 23 Page



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1. SPECIFICATIONS

1.1 Features

Main LCD Panel

Item	Standard Value
Display Type	320* (R 、G 、B) * 480 Dots
LCD Type	a-Si TFT , Normally white TN mode , Transmissive
Screen size(inch)	3.2(Diagonal)
Viewing Direction	12 O'clock
Color configuration	R.G.B. vertical stripe
Backlight	White LED
Interface	16-bit interface for DBI Type B
Other(controller / driver IC)	ILI9481

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	51.5(W) * 78.5 (L) * 2.8(H)	mm

LCD Panel

Item	Standard Value	Unit
Viewing Area	46.64(W) * 68.96 (L)	mm
Active Area	44.64 (W) * 66.96(L)	mm

Note : For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
	VCI	-	-0.3	+4.6	V
Sustan Davier Supply Voltage	IOVCC		-0.3	+4.6	
System Power Supply Voltage	VGH	-	-0.3	+18.5	V
	VGL	-	-0.3	+18.5	V
Input Voltage	VIN	-	-0.3	IOVCC+0.3	V
Operating Temperature	T _{OP}	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C
Storage Humidity	H_{D}	Ta \leq 40 °C	20	90	%RH

1.4 DC Electrical Characteristics

Module

GND = 0V, Ta = 25°C

					,	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage1	VCI	-	-	2.8	-	V
Power Supply Voltage2	IOVCC	-	-	2.8	-	V
Input High Voltage	V _{IH}	-	0.7 *IOVCC	-	IOVCC	V
Input Low Voltage	V _{IL}	-	0	-	0.3*IOVCC	V
Output High Voltage	V _{OH}	IOH=-0.1mA	0.8*IOVCC	-	IOVCC	V
Output Low Voltage	V _{OL}	IOL=0.1mA	0	-	0.2*IOVCC	V
Supply Current	IDD	VDD= 2.8V, Pattern=BLACK*1	-	12	18	mA

Note1 : Maximum current display



1.5 Optical Characteristics

TFT LCD Panel

VDD = 2.8V, Ta=25°C

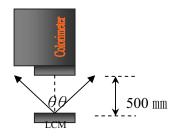
						2.0	v, iu	
Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response tin	ne	Tr + Tf	Ta = 25°C θX, θY = 0°	-	30	45	ms	Note2
	Тор	θY+	 CR ≥ 10	-	50	-		
Viewing angle	Bottom	θY-		-	45	-	Deg.	Note4
	Left	θХ-		-	50	-	Deg.	NOLE4
	Right	θX+		-	50	-		
Contrast rati	0	CR		200	250	-	-	Note3
	\//bita	Х	Ta = 25°C θX , θY = 0°	0.23	0.28	0.33		Note1
	White	Y		0.25	0.30	0.35		
	Red	Х		0.58	0.63	0.68		
Color of CIE Coordinate		Y		0.29	0.34	0.39		
(With B/L)	Green	Х		0.29	0.34	0.39		
		Y		0.56	0.61	0.66		
	Blue	Х		0.1	0.15	0.2		
	Dide	Y		0.03	0.08	0.13		
Average Brightness								
Pattern=white display		IV	IF= 100mA	200	230	-	cd/m ²	Note1
(With B/L)								
Uniformity (With B/L)		∆B	IF= 100mA	80	-	-	%	Note1

Note1:

 $1 : \triangle B=B(min) / B(max) \times 100\%$

- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C ±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: 500 \pm 50 mm \rightarrow (θ = 0°)
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01 , Average Brightness ± 4%





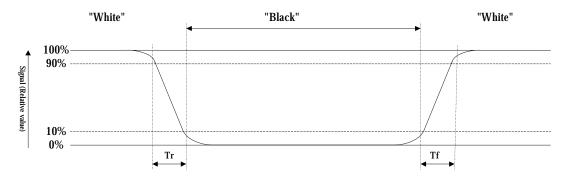
Colorimeter=BM 7 fast



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

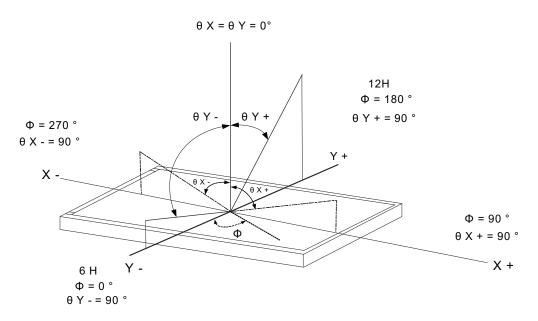
Contrast ratio is calculated with the following formula

Contrast ratio (CR) =

Photo detector output when LCD is at "White" state

Photo detector output when LCD is at "Black" state Note4: Definition of viewing angle:

Refer to figure as below:





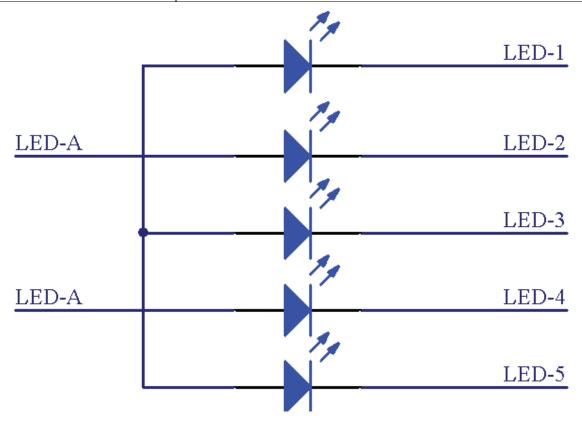
1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25 ℃	-	150	mA
Forward Voltage	VF	Ta =25 ℃	-	4	V
Reverse Voltage	VR	Ta =25 ℃	-	5	V
Power Dissipation	PD	Ta =25 ℃	-	360	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF= 100mA	-	3.5	3.6	V
Average Brightness (without LCD)	IV		4500	4800	-	cd/m ²
Color of CIE Coordinate	Х	IF= 100mA	0.24	0.27	0.30	
(without LCD)	Y		0.24	0.27	0.30	-
Color			White			



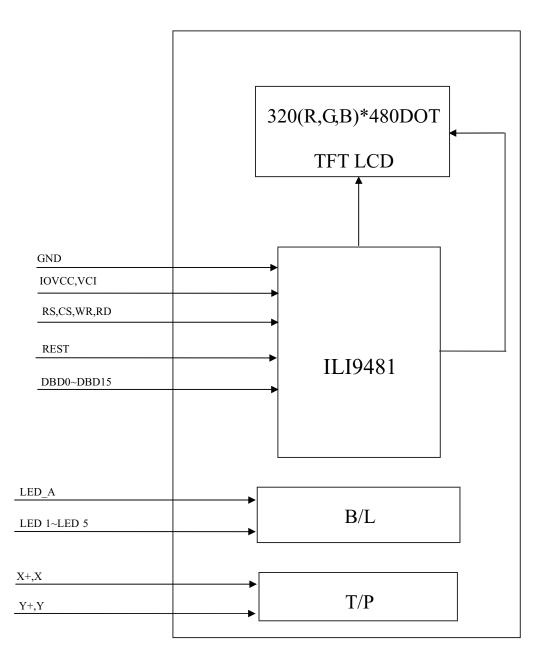


2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

- * See Appendix
- 2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function						
1	GND	System ground.(0V)						
2	IOVCC	Power supply.(2.8V)						
3	VCI	Power supply.(2.8V)						
4	CS	Chip select signal, active "L".						
5	RS	Command/Display data selection. 0:Command 1:Display data						
6	WR	Write signal input, active "L".						
7	RD	Read signal input, active "L".						
8	REST	Reset input pin. When RESET is "L", initialization is executed.						
9	DBD0	Bi-directional data bus.						
10	DBD1	Bi-directional data bus.						
11	DBD2	Bi-directional data bus.						
12	DBD3	Bi-directional data bus.						
13	DBD4	Bi-directional data bus.						
14	DBD5	Bi-directional data bus.						
15	DBD6	Bi-directional data bus.						
16	DBD7	Bi-directional data bus.						
17	DBD8	Bi-directional data bus.						
18	DBD9	Bi-directional data bus.						
19	DBD10	Bi-directional data bus.						
20	DBD11	Bi-directional data bus.						
21	DBD12	Bi-directional data bus.						
22	DBD13	Bi-directional data bus.						
23	DBD14	Bi-directional data bus.						
24	DBD15	Bi-directional data bus.						
25	GND	System ground.(0V)						

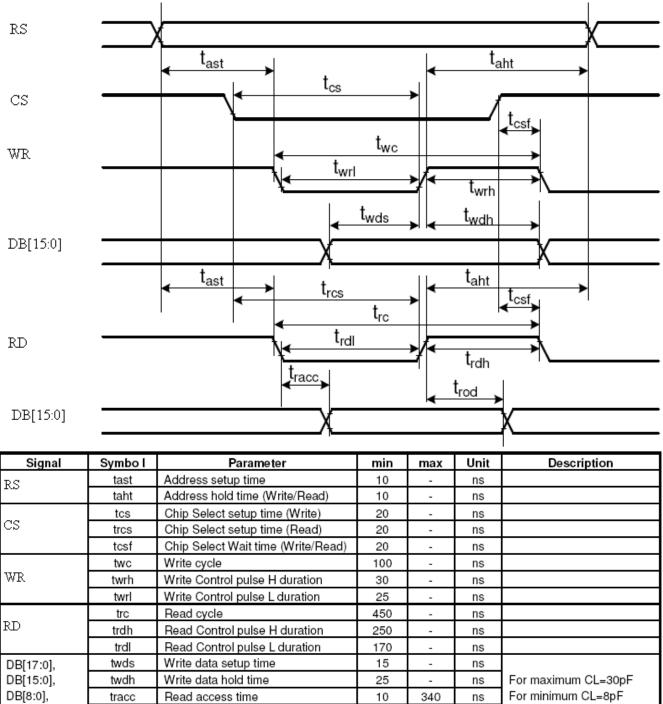


Pin No.	Symbol	Function
26	Y-	Touch Panel control pin.
27	Х-	Touch Panel control pin.
28	Y+	Touch Panel control pin.
29	X+	Touch Panel control pin.
30	LED-1	Power supply for LED Backlight Cathode input.
31	LED-2	Power supply for LED Backlight Cathode input.
32	LED-3	Power supply for LED Backlight Cathode input.
33	LED-4	Power supply for LED Backlight Cathode input.
34	LED-5	Power supply for LED Backlight Cathode input.
35	LED-A	Power supply for LED Backlight Anode input.
36	LED-A	Power supply for LED Backlight Anode input.
37	GND	System ground.(0V)



2.3 Timing Characteristics

DBI Type B Interface



DB[7:0]

Note: Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

Read output disable time

Note: Ta = -30 to 70 °C, IOVCC=1.65V to 3.3V, VCI=2.5V to 3.3V, GND=0V

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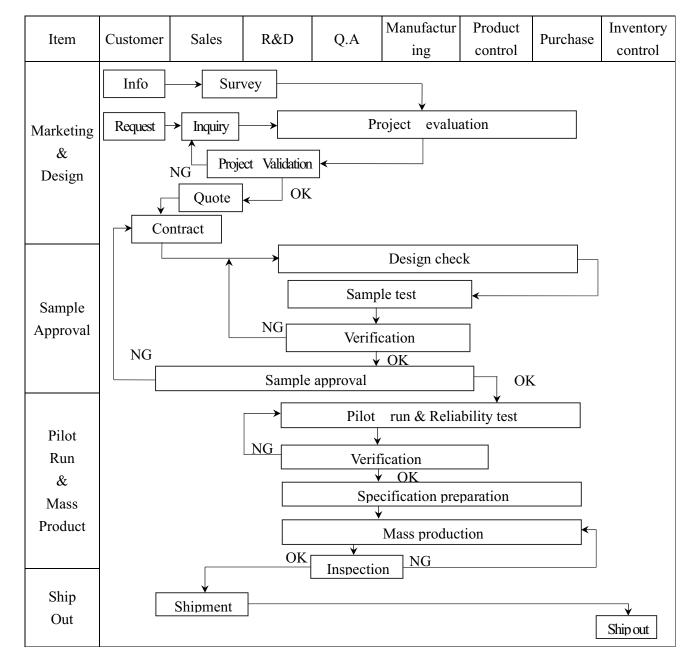
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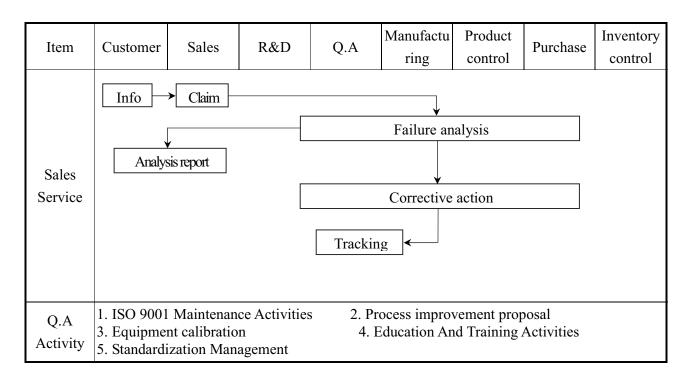
3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





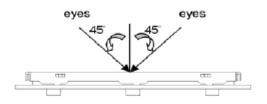




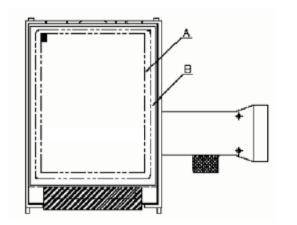


3.2 Inspection Specification

- Scope : The document shall be applied to TFT-LCD Module for less than 3, 5" (Ver.B01).
- ◆Inspection Standard:MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge、MIL-STD、 Sample
- ◆Defect Level : Major Defect AQL : 0, 4 ; Minor Defect AQL : 1, 5
- OUT Going Defect Level : Sampling.
- Standard of the product appearance test :
 - a. Manner of appearance test :
 - (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



♦Spe	cification For TFT-LC	D Module Less T	`han 3.5" :	((Ver.02)									
NO	Item		Criter	ion	Level									
		1. 1The part nu production		t with work order of	Major									
01	Product condition	1. 2 Mixed product types.												
		1. 3 Assembled in inverse direction.												
02	Quantity	2. 1The quantit	2. 1 The quantity is inconsistent with work order of production.											
03	Outline dimension	3.1 Product di diagram.	mension and struct	ure must conform to structure	Major									
		4.1 Missing lin	4.1 Missing line character and icon.											
		4. 2 No function or no display.												
04	Electrical Testing	4. 3 Display malfunction.												
		4. 4 LCD viewing angle defect.												
		4.5 Current co	4.5 Current consumption exceeds product specifications.											
				·										
			Item	Acceptance (Q'ty)										
	Dat datat		Bright Dot	≤ 2										
	Dot defect	Dot	Dark Dot	≦ 3										
	(Bright dot \	Defect	Joint Dot	≦ 2										
05	Dark dot)		Total	≦ 3	Minor									
	On -display	5.1 Inspection	5. 1 Inspection pattern : full white , full black , Red , Green and											
			blue scree	ns.										
		5.2 It is defined	l as dot defect if def	fect area >1/2 dot.										
		5.3 The distant	e between two dot	defect ≥ 5 mm.										



NO	Item	Module Less Tha		terion		(Ver. 02) Level			
06	Black or white dot \cdot scratch \cdot contamination Round type $\downarrow_X \qquad \downarrow_Y $	Dimension 0.15 < 0.20 <	0.03 < W) According to the second sec	eptance (Q'ty) Ignore 2 2 0 3	Minor			
07	Polarizer Bubble	0.20 < 0	0 > 0.50	Acc	Acceptance (Q'ty) Ignore 3 0 3				

.



NO	Item		Criterion		Level
NO	ication For TFT-LCD I Item	t: The thic 8.1 General	gth of crack kness of crack Y kness of glass Z glass chip : on panel surface and cra X Y Y		(Ver. 02) Level
08	The crack of glass	X	Y [OK] Seal width Z Y Crack can't enter	[NG]	WIIIO
		≦ a	≦1/2 t		
		≦ a	Crack can't exceed the	$1/2 t < Z \leq 2 t$	

-



	fication For TFT-LCD	Module Less			(Ver.02)
NO	Item		Criterion		Level
		Z : The th t : The thi	ickness of crack V	Y : The width of crack. V : terminal length a : LCD side length	
		x	Y	Z	
		≦1/5 a	Crack can't enter viewing area	$Z \leq 1/2 t$	
		≦1/5 a	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	
08	The crack of glass	accore at con to	sion over terminal : p on electrode pad : X X X X X X X X X X	$/2 W \leq t$	_ Mino
		Back	$\leq a \leq$	W $\leq 1/2 t$	



NO	Item	Criterion	Level
NO 08	Item The crack of glass	CriterionSymbols :X : The length of crack Z : The thickness of crack t : The thickness of glassY : The width of crack. W : terminal length a : LCD side length8. 2. 2 Non-conductive portion :YYYXYXXYXYXYS1/3 a \subseteq 1/3 aSW \subseteq 1/3 aYSYSSSSSYSYSYSYSYSYSYSYSSSIf the chipped area touches the ITO terminal, over 2/3 of	Minor
		the ITO must remain and be inspected according to electrode terminal specifications. 8. 2. 3 Glass remain : V = V = V = V = V = V = V = V = V = V =	



♦Speci	fication For TFT-LC	CD Module Less Than 3.5":	(Ver.02)							
NO	Item	Criterion	Level							
		9. 1 Backlight can't work normally.								
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.								
		9. 3 Illumination source flickers when lit.								
		10. 1 Pin type < quantity < dimension must match type in structure diagram.	Major							
		10. 2 No short circuits in components on PCB or FPC .	Major							
	General	10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major							
10	appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor							
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor							
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor							



4. RELIABILITY TEST

4.1 Reliability Test Condition

Ver.02

4.1	Reliability Test Cond			vel.02								
NO.	TEST ITEM	TEST CON	NDITION									
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then st	orage at normal condition	4hrs.								
2	Low Temperature Storage Test	Keep in -30 ±2℃ 96 hrs Surrounding temperature, then st	orage at normal condition	4hrs.								
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duratio Surrounding temperature, then st (Excluding the polarizer)		4hrs.								
		Air Discharge:	Contact Discharge:									
		Apply 2KV with 5 times	Apply 250V with 5 time									
		Discharge for each polarity +/- 1. Temperature ambiance : 15°C ·	discharge for each pola	nrity +/-								
4	ESD Test	 Humidity relative : 30%~60% Energy Storage Capacitance(Cs+Cd) : 150pF±10% Discharge Resistance(Rd) : 330Ω±10% Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%) 										
		$-20^{\circ}C \rightarrow +25^{\circ}C \rightarrow +70^{\circ}C \rightarrow +25^{\circ}C$										
5	Temperature Cycling		(30mins) (5mins)									
	Storage Test	10 Cy		/hrs								
		Surrounding temperature, then storage at normal condition 4hrs.										
,	5.761 (* 1751 (1. Sine wave $10 \sim 55$ Hz frequence	•									
6	Vibration Test (Packaged)	 The amplitude of vibration :1. Each direction (X \ Y \ Z) due 										
	(1	3. Each direction $(X \lor Y \lor Z)$ due										
		Packing Weight (Kg)	Drop Height (cm)									
		0 ~ 45.4	122									
7	Drop Test	45.4 ~ 90.8 76										
,	(Packaged)	90.8 ~ 454 61										
		0ver 454 46										



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}C \pm 5^{\circ}C$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

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C D E F C H (1,28)	V BY	DRAWING						44		PITCH 1.0*(37-1)=36±0.05 W=0.54						C ¹ Cl			-							DIRECTION		-				320x3(RGB)X480 D01							44.64(A.A)	46.64(V.A)	48.94(LCD)				Φ
Image: constraint of the	REVISER	Shawn						3.8	2±0 8±0					6±	0.3 ±0.	3							_	_	_							- -	_							(2.43)	(1.28)				C
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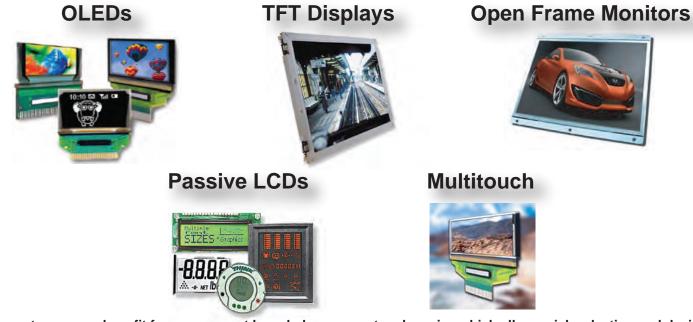


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Displays

US Micro Products is an industrial distributor specializing in engineered display solutions. We dedicate ourselves to providing the best in displays for the medical, industrial, gaming, automotive, aerospace, military, and consumer markets.



As a customer, you benefit from our expert knowledge, support and service which allow quick selection and design-in of the best display for your application. On hand stock and demo boards facilitate quick access and evaluation to get you going fast. Our technical sales staff and experienced design engineers provide answers to your questions as well as engineered solutions to solve your display needs.

Peripheral Devices

Our full line of peripheral devices includes keyboards, trackballs, and printers. These rugged industrial products are designed to meet your demanding requirements and are available as both standard and custom solutions.

